

Device Loan Agreement

Borrower name: Current address: Phone number:			
		Conditions for Use	
		The device is available for a maximum lo	an period of up tocalendar days.
In accordance with the Be Connected D	igital Devices grant guidelines, ge the loan process, be responsible for repairs of		
any faults, manage any breakages, and re also ensure appropriate and thorough cle	esolve any issues with the loaned device. They will eaning of the device prior to loan.		
If anything is to happen to the device wh	ilst it is on loan to you, you must contact possible.		
This device must be returned to location.	at the agreed-upon date and		
you have added a password, lock code c	et and all information will be deleted. Therefore, if or any other account information you must be able bu should also remove any personal information,		
The borrower agrees not to perform una fraud, buying or selling illegal goods and	uthorised or illegal actions, for example, hacking, more.		
I understand that I am fully responsible for taking care of this borrowed device and any accompanying accessories, and for its return to			
I have read, understand, and agree t and the Device Usage Guidelines.	to the Conditions of Use listed in this agreement		
agree to return the device by the c	lue date noted below		
The device will be returned on:			
Borrower Signature:	Date:		





